

Product Change Notification



PMG - Microelectronics (also DBA as White Electronic Designs Co.) is a wholly owned subsidiary of Microsemi Corp.

Date: Thursday, October 17, 2013

PCN#: 140A00217

Subject: Part Number Change due to Package shrinks.

Dear Customers,

Microsemi PMG would like to inform you that the following products will be affected by the part number change due to package shrinks:

Status	Density (MB)	Organization	Part Number	Die Type	Speed (Mb/s)	Volt	Package	Dimensions (mm x mm x mm)
Current Production	256	32Mx64	W3E32M64S-XBX	Current	200-333	2.5	219 PBGA	25.1 x 25.1 x 2.03
Current Production	256	32Mx72	W3E32M72S-XBX	Current	200-333	2.5	219 PBGA	32.1 x 25.1 x 2.03

The package dimensions with the new part number are as follows:

Status	Density (MB)	Organization	Part Number	Die Type	Speed (Mb/s)	Volt	Package	Dimensions (mm x mm x mm)
Under Development	256	32Mx64	W3E32M64S-XB2X	New Shrink	200-333	2.5	219 PBGA	21 x 21 x 2.03
Under Development	256	32Mx72	W3E32M72S-XB2X	New Shrink	200-333	2.5	219 PBGA	21 x 21 x 2.03

The affected products will continue to be supported until the parts are qualified. Please contact your Sales representative for questions related to this change.

Best regards,

Microsemi Power and Microelectronics Group Engineering